SDLS007

D2635, JANUARY 1981-REVISED MARCH 1988

- 8-Bit Parallel Storage Register Inputs ('LS597)
- Parallel 3-State I/O, Storage Register Inputs, Shift Register Outputs ('LS598)
- Shift Register has Direct Overriding Load and Clear
- Accurate Shift-Frequency . . . DC to 20 MHz

description

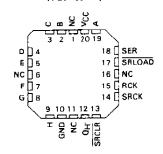
The 'LS597 comes in a 16-pin package and consists of an 8-bit storage latch feeding a parallel-in, serial-out 8-bit shift register. Both the storage register and shift register have positive-edge triggered clocks. The shift register also has direct load (from storage) and clear inputs.

The 'LS598 comes in a 20-pin package and has all the features of the 'LS597 plus 3-state I/O ports that provide parallel shift register outputs and also has multiplexed serial data inputs.

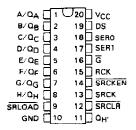
SN54LS597 . . . J OR W PACKAGE SN74LS597 . . . N PACKAGE (TOP VIEW)



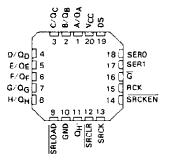
SN54LS597 . . . FK PACKAGE (TOP VIEW)



SN54LS598 . . . J OR W PACKAGE LS598 . . . DW OR N PACKAGE (TOP VIEW)

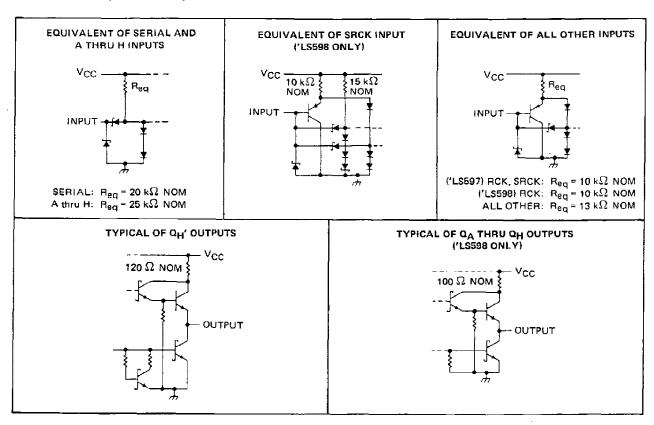


SN54LS598 . . . FK PACKAGE (TOP VIEW)

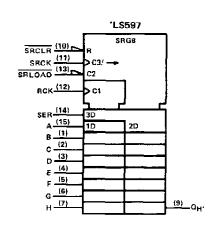


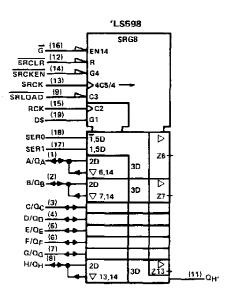
NC - No internal connection

schematics of inputs and outputs



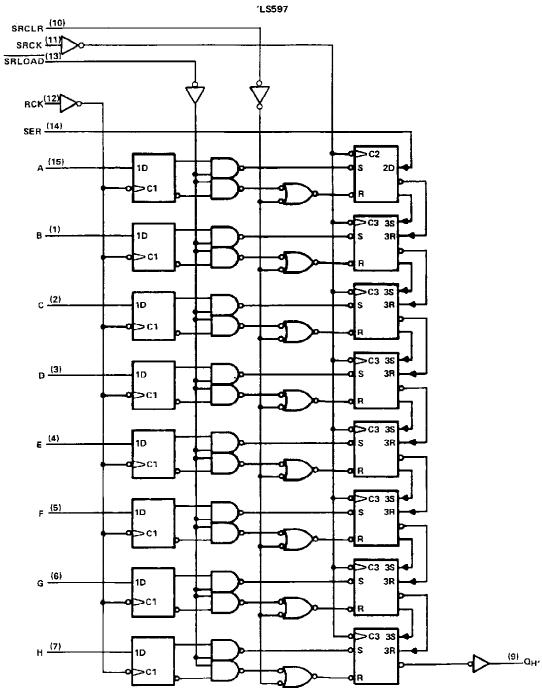
logic symbols †



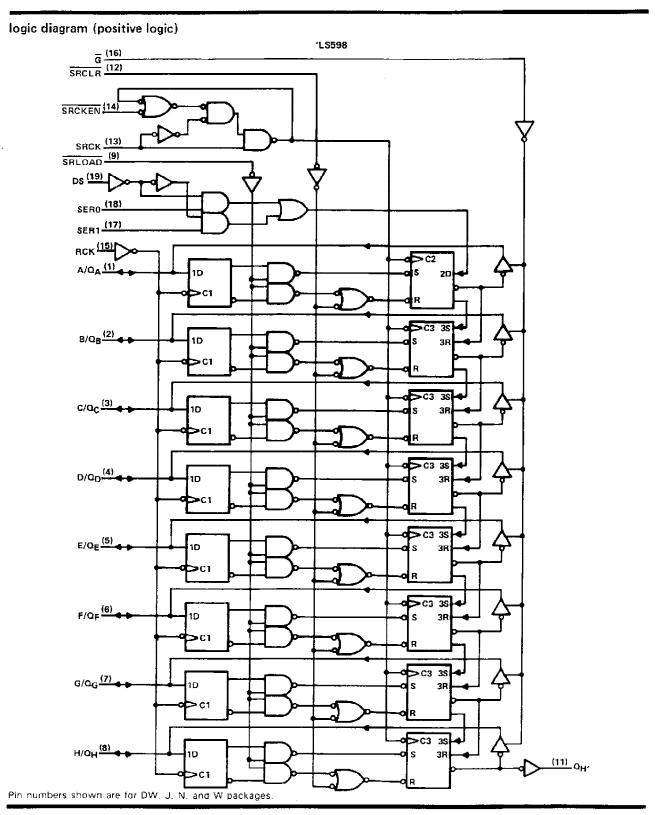


[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, N, and W packages.

logic diagram (positive logic)



Pin numbers shown are for DW, J, N, and W packages.



NOTE 1: Voltage values are with respect to the network ground terminal,

recommended operating conditions

				•	' SN54LS'			SN74LS'			UNIT
				1	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage				4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input v	oltage			2			2			٧
VIL	Low-level input vi	oltage			0.7			0.8	V		
	I Policia di La como		ΩH'		l		- 1			– 1	mΑ
іон	High-level output	current	QA thru Q	, 'L\$598 only		- 1			- 2.6		7 mA
1			ΩH				8			16	
IOL	Low-level output current		QA thru Q+	, 'L\$598 only			12			24	mA
fsck	Shift clock freque	псу	γ				20	0		20	MHz
			CDCK	hīgh	15			15			
			SACK	low	35			35			
t _w	Pulse duration		RCK SRCLR					20			n\$
		Data before RC						20			
			SRLOAD		40			40			
		Data before F	RCK1		20			20			1
	-	DS before SF	CK † ('LS598	only)	30			30			1
		SRCK EN ION	2 0.7 Part QH' -1 QA thru QH, 'LS598 only -1 OA thru QH, 'LS598 only 12 O 20 0 SRCK high 15 15 Iow 35 35 RCK 20 20 SRCLR 20 20 SRCLR 20 20 SRLOAD 40 40 Data before SRCK 1 ('LS598 only) 30 30 SRCKEN low before SRCK 1 ('LS598 only) 20 SRCLR 10 20 20 SRCLR 20 20 SRCLR 20 20 SRCLR 20 20 SRCLR 20 20 SRLOAD 40 40 A0 40 DS before SRCK 1 ('LS598 only) 30 30 SRCKEN low before SRCK 1 ('LS598 only) 20 SRCLR inactive before SRCK 1 25 SRLOAD inactive before SRCK 1 30 30 RCK 1 before SRLOAD 1 (see Note 2) 40 40 SER before SRCK 1 20 20 O 0								
t _{su}	Setup time	Current QH'			ns						
		SRLOAD ina	A.5 5 5.5 4.75								
		RCK 1 before SRLOAD 1 (s	e Note 2)	40			40				
		SER before S	ACK t					20			
th	Hold time				0			0			ns
TA	Operating free-air	temperature	- 55		125	0		70	°C		

NOTE 2: The RCK 1 before SRLOAD 1 setup time ensures the data saved by RCK 1 will also be loaded into the shift register.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		T		••••t		SN54LS	,	. :	SN74LS	,	UNIT
PARAMETER		•	EST CONDITIO	NS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	CIVIT
Vik		VCC = MIN,	I _I = - 18 mA				- 1.5			- 1.5	٧
	T	VCC = MIN,	V= 2 V	I _{OH} = - 1 mA	2.4	3.2					
∨он	'LS598 Q	ACC - MAX	VIH - Z V,	I _{OH} = - 2.6 mA				2.4	3.1		V
	α _H ′	VIL-WAX		i _{OH} = - 1 mA	2.4	3.2		2.4	3.2		
	'LS598 Q			I _{OL} = 12 mA		0.25	0.4		0.25	0.4	
Vo∟	C3396 G	V _{CC} = MIN,	$V_{1H} = 2 V$,	IOL = 24 mA			<u> </u>		0.35	0.5	v
VOL	ΩH,	V _{IL} ≃ MAX		IOL = 8 mA		0.25	0.4	ļ	0.25	0.4	
	ЧН	3		IOL = 16 mA				L	0.35	0.5	
lozh	'L\$598 Q	V _{CC} = MAX, V _O = 2.7 V	V _{IH} = 2 V,	V _{1L} = MAX,			20			20	μA
lozt	'LS598 Q	V _{CC} = MAX, V _O = 0.4 V	V _{IH} = 2 V,	VIL = MAX,			- 0.4			- 0.4	mА
	'LS598 Q		-	V ₁ = 5.5 V			0.1			0.1	mA
11	Others	VCC = MAX		V ₁ = 7 V			0.1			0,1	m A
ЧН	· · · · · · · · · · · · · · · · · · ·	VCC = MAX.	V _I = 2.7 V	•			20			20	μА
	'L\$598 SRCK				Ì		- 0.8			- 0.8	
11L	SER, A Thru H	VCC = MAX,	V _I = 0.4 V				- 0.4			- 0.4	mA
	Others						- 0.2			- 0.2	
los§	'LS598 Q	V _{CC} = MAX,	Vo = 0 V		- 30		- 130	- 30		- 130	m.A.
אצטי	ΩH'	1 100 1100	•0 ••		- 20		– 100	- 20		<u> </u>	
	'LS597 ICCH				<u> </u>	35	53		35	53	
	lccr	V _{CC} = MAX,				35	53		35	53	
lcc	Іссн	All possible inc	outs grounded,	uts grounded,		45	68		45	68	mΑ
	'LS598 ICCL	All outputs op	en			54	80		54	80	
	CCZ					56	85		56	85	

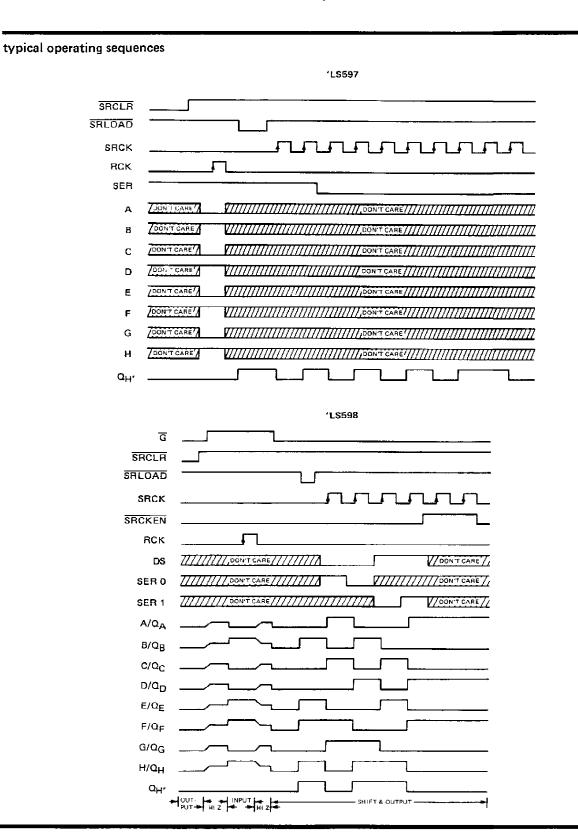
[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $[\]ddagger$ All typical values are at V_{CC} \pm 5 V, T_A \pm 25°C §Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25 \,^{\circ}\text{C}$, (see note 3)

	FROM	то				1 S597	,	'LS598			UNIT
PARAMETER	(INPUT)	(OUTPUT)	TEST CON	TEST CONDITIONS			MAX	MIN	TYP	MAX	
fmax	SRCK	a	$R_L = 667 \Omega$,	CL = 45 pF	20	35		20	35		MHz
f _{max}	SRCK	QH'	$R_L = 1 k\Omega$	C _L = 30 pF	20	35					MHz
tPLH	SRCK†	ΩH'				15	23		11	17	ns
tPHL .	SPCK1	QH'	R _L = 1 kΩ,	0 20 -5		20	30		15	23	กร
†PLH	SRLOAD↓	ΩH,		C(= 30 pr		38	57		28	42	กร
^T PHL	SRLOAD↓	α _H '				29	44		20	30	ns
t _{PHL}	SRCLR	α _H '				24	36		18	27	ns
^t PLH	RCK1	α _H ′	$R_L = 1 \text{ k}\Omega$	$C_L = 30 pF$		41	60		32	48	ns
[†] PHL	RCK1	αH.	SRLOAD = L			32	48		24	36	ns
[†] PLH	SRCK†	a							12	18	ns
[†] PHL	SRCK1	α	1					19	28	ПБ	
^t PLH	SRLOAD↓	Q						32	48	ns	
†PHL	SRLOAD↓	Q	R _L = 667 Ω.	C _L = 45 pF					27	40	пѕ
TPHL	SRCLR+	α							25	38	ns
[†] PZH	G↓	a							26	31	ns
tPZL	G∔	a							29	43	ns
t _{PHZ}	Gt	Q		2 5 5					25	38	ns
tPLZ	Gt	Q	$\mathbf{A_L} = 667 \Omega,$	CL = 5 pF					20	30	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.







6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-89444012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 89444012A SNJ54LS 597FK	Samples
5962-8944401EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8944401EA SNJ54LS597J	Samples
5962-8944401EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8944401EA SNJ54LS597J	Samples
5962-8944401FA	ACTIVE	CFP	W	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8944401FA SNJ54LS597W	Samples
5962-8944401FA	ACTIVE	CFP	W	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8944401FA SNJ54LS597W	Samples
SN74LS597D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS597	Samples
SN74LS597D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS597	Samples
SN74LS597N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS597N	Samples
SN74LS597N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS597N	Samples
SN74LS598N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS598N	Samples
SN74LS598N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS598N	Samples
SNJ54LS597FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 89444012A SNJ54LS 597FK	Samples
SNJ54LS597FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 89444012A SNJ54LS 597FK	Samples
SNJ54LS597J	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8944401EA SNJ54LS597J	Samples



PACKAGE OPTION ADDENDUM

6-Feb-2020

Orderable Device	Status	Package Type	_	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SNJ54LS597J	ACTIVE	CDIP	J	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8944401EA SNJ54LS597J	Samples
SNJ54LS597W	ACTIVE	CFP	W	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8944401FA SNJ54LS597W	Samples
SNJ54LS597W	ACTIVE	CFP	W	16	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8944401FA SNJ54LS597W	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

6-Feb-2020

OTHER QUALIFIED VERSIONS OF SN54LS597, SN74LS597:

• Military: SN54LS597

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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